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May 1995 Revised April 2001

74LCX16543

Low Voltage 16-Bit Registered Transceiver with 5V Tolerant Inputs and Outputs

General Description

The LCX16543 contains sixteen non-inverting transceivers containing two sets of D-type registers for temporary storage of data flowing in either direction. Each byte has separate control inputs which can be shorted together for full 16-bit operation. Separate Latch Enable and Output Enable inputs are provided for each register to permit independent input and output control in either direction of data flow.

The LCX16543 is designed for low voltage (2.5V or 3.3V) V_{CC} applications with capability of interfacing to a 5V signal applications.

The LCX16543 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Features

- 5V tolerant inputs and outputs
- 2.3V-3.6V V_{CC} specifications provided
- 5.2 ns t_{PD} max ($V_{CC} = 3.3V$), 20 μ A I_{CC} max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- \pm 24 mA Output Drive (V_{CC} = 3.0V)
- Implements patented noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance:

Human Body Model > 2000V

Machine Model > 200V

Note 1: To ensure the high-impedance state during power up or down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

Ordering Code:

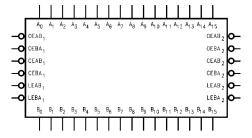
Order Number	Package Number	Package Description
74LCX16543MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide
74LCX16543MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Logic Symbol



Pin Descriptions

Pin Names	Description
OEAB _n	A-to-B Output Enable Input (Active LOW)
OEBA _n B-to-A Output Enable Input (Active LOW)	
CEAB _n	A-to-B Enable Input (Active LOW)
CEBAn	B-to-A Enable Input (Active LOW)
LEAB _n	A-to-B Latch Enable Input (Active LOW)
LEBAn	B-to-A Latch Enable Input (Active LOW)
A ₀ -A ₁₅	A-to-B Data Inputs or B-to-A 3-STATE Outputs
B ₀ -B ₁₅	B-to-A Data Inputs or A-to-B 3-STATE Outputs

Data I/O Control Table

	Inputs		Latch Status	Output Buffers
CEAB _n	$\overline{\text{LEAB}}_{\text{n}}$	$\overline{\text{OEAB}}_{\text{n}}$	(Byte n)	(Byte n)
Н	Х	Х	Latched	High Z
X	Н	X	Latched	_
L	L	X	Transparent	_
X	X	Н	_	High Z
L	X	L	_	Driving

H = HIGH Voltage Level

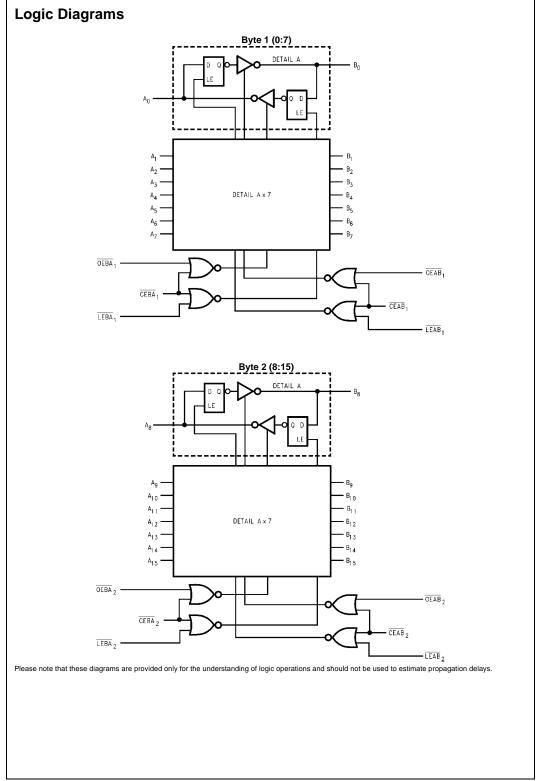
Functional Description

The LCX16543 contains sixteen non-inverting transceivers with 3-STATE outputs. The device is byte controlled with each byte functioning identically, but independent of the other. The control pins may be shorted together to obtain full 16-bit operation. The following description applies to each byte. For data flow from A to B, for example, the A-to-B Enable (\overline{CEAB}_n) input must be LOW in order to enter data from $\mathrm{A}_0\mathrm{-A}_{15}$ or take data from $\mathrm{B}_0\mathrm{-B}_{15}$, as indicated in the Data I/O Control Table. With $\overline{\text{CEAB}}_{\text{n}}$ LOW, a LOW signal on the A-to-B Latch Enable (LEABn) input

makes the A-to-B latches transparent; a subsequent LOWto-HIGH transition of the $\overline{\text{LEAB}}_n$ signal puts the A latches in the storage mode and their outputs no longer change with the A inputs. With $\overline{\text{CEAB}}_n$ and $\overline{\text{OEAB}}_n$ both LOW, the 3-STATE B output buffers are active and reflect the data present at the output of the A latches. Control of data flow from B to A is similar, but using the \overline{CEBA}_n , \overline{LEBA}_n and OEBA_n inputs.

L = LOW Voltage Level

 $X = Immaterial \\ A-to-B data flow shown; B-to-A flow control is the same, except using \overline{CEBA}_n, \overline{LEBA}_n and \overline{OEBA}_n.}$



Absolute Maximum Ratings(Note 2)

Symbol	Parameter	Value	Conditions	Units
V _{CC}	Supply Voltage	−0.5 to +7.0		V
VI	DC Input Voltage	−0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to $V_{CC} + 0.5$	Output in HIGH or LOW State (Note 3)	v
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA
I _{OK}	DC Output Diode Current	-50	V _O < GND	mA
		+50	V _O > V _{CC}	IIIA
I _O	DC Output Source/Sink Current	±50		mA
I _{CC}	DC Supply Current per Supply Pin	±100		mA
I _{GND}	DC Ground Current per Ground Pin	±100		mA
T _{STG}	Storage Temperature	-65 to +150		°C

Recommended Operating Conditions (Note 4)

Symbol	Parameter	Min	Max	Units	
V _{CC}	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	V
V _I	Input Voltage		0	5.5	V
Vo	Output Voltage	HIGH or LOW State	0	V _{CC}	V
		3-STATE	0	5.5	V
I _{OH} /I _{OL}	Output Current	$V_{CC} = 3.0V - 3.6V$ $V_{CC} = 2.7V - 3.0V$ $V_{CC} = 2.3V - 2.7V$		±24	
		$V_{CC} = 2.7V - 3.0V$		±12	mA
		$V_{CC} = 2.3V - 2.7V$		±8	
T _A	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = 3.0V		0	10	ns/V

Note 2: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 4: Unused (inputs or I/Os) must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	Conditions	v _{cc}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	
Syllibol		Conditions	(V)	Min	Max	Ullits	
V _{IH}	HIGH Level Input Voltage		2.3 – 2.7	1.7		V	
		2.7 -		2.0		V	
V _{IL}	LOW Level Input Voltage		2.3 – 2.7		0.7	V	
			2.7 – 3.6		0.8	V	
V _{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.3 – 3.6	V _{CC} - 0.2			
		$I_{OH} = -8 \text{ mA}$	2.3	1.8			
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		V	
		$I_{OH} = -18 \text{ mA}$	3.0	2.4			
		$I_{OH} = -24 \text{ mA}$	3.0	2.2			
V _{OL}	LOW Level Output Voltage	$I_{OL} = 100 \mu A$	2.3 – 3.6		0.2		
		$I_{OL} = 8 \text{ mA}$	2.3		0.6		
		I _{OL} = 12 mA	2.7		0.4	V	
		I _{OL} = 16 mA	3.0		0.4		
		I _{OL} = 24 mA	3.0		0.55		
l _l	Input Leakage Current	0 ≤ V _I ≤ 5.5V	2.3 – 3.6		±5.0	μΑ	
l _{oz}	3-STATE I/O Leakage	$0 \le V_O \le 5.5V$	2.3 – 3.6		±5.0	^	
		$V_I = V_{IH}$ or V_{IL}	2.3 - 3.0		±3.0	μΑ	
OFF	Power-Off Leakage Current	V_I or $V_O = 5.5V$	0		10	μΑ	

Note 3: I_O Absolute Maximum Rating must be observed.

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC}	$T_A = -40^{\circ}$	C to +85°C	Units
Cymbol	i didilicici	Conditions	(V)	Min	Max	Onico
I _{CC}	Quiescent Supply Current	$V_I = V_{CC}$ or GND	2.3 – 3.6		20	μА
		$3.6V \le V_1, V_0 \le 5.5V \text{ (Note 5)}$	2.3 – 3.6		±20	μΑ
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	2.3 – 3.6		500	μΑ

Note 5: Outputs in disabled or 3-STATE only.

AC Electrical Characteristics

		$T_A = -40$ °C to $+85$ °C, $R_L = 500 \Omega$						
Symbol	Parameter	V _{CC} = 3.	3V ± 0.3V	V _{CC}	= 2.7V	V _{CC} = 2	.5V ± 0.2V	Units
	Farameter	C _L =	C _L = 50 pF		C _L = 50 pF		C _L = 30 pF	
		Min	Max	Min	Max	Min	Max	1
t _{PHL}	Propagation Delay	1.5	5.2	1.5	6.0	1.5	6.2	ns
t _{PLH}	A_n to B_n or B_n to A_n	1.5	5.2	1.5	6.0	1.5	6.2	115
t _{PHL}	Propagation Delay	1.5	6.5	1.5	7.5	1.5	7.8	ns
t _{PLH}	\overline{LEBA}_{n} to A_{n} or \overline{LEAB}_{n} to B_{n}	1.5	6.5	1.5	7.5	1.5	7.8	115
t _{PZL}	Output Enable Time							
t _{PZH}	\overline{OEBA}_n or \overline{OEAB}_n to A_n or B_n	1.5	6.5	1.5	7.0	1.5	8.5	ns
	$\overline{\text{CEBA}}_{\text{n}}$ or $\overline{\text{CEAB}}_{\text{n}}$ to A_{n} or B_{n}	1.5	6.5	1.5	7.0	1.5	8.5	
t _{PLZ}	Output Disable Time							
t_{PHZ}	\overline{OEBA}_n or \overline{OEAB}_n to A_n or B_n	1.5	6.5	1.5	7.0	1.5	7.8	ns
	$\overline{\text{CEBA}}_{\text{n}}$ or $\overline{\text{CEAB}}_{\text{n}}$ to A_{n} or B_{n}	1.5	6.5	1.5	7.0	1.5	7.8	
t _S	Setup Time, HIGH or LOW,	2.5		2.5		3.0		ns
	Data to LEXX _n							115
t _H	Hold Time, HIGH or LOW,	1.5		1.5		2.0		
	Data to LEXX _n							ns
t _W	Pulse Width, Latch Enable, LOW	3.0		3.0		3.5		ns
toshl	Output to Output Skew (Note 6)		1.0					
toslh			1.0					ns

Note 6: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = 25°C	Units
V _{OLP}	Quiet Output Dynamic Peak VOI	$C_{L} = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{II} = 0 \text{V}$	3.3	0.8	
OLI	32	C _L = 30 pF, V _{IH} = 2.5V, V _{IL} = 0V	2.5	0.6	V
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	-0.6	V

Capacitance

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	V_{CC} = Open, V_I = 0V or V_{CC}	7	pF
C _{I/O}	Input/Output Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC} , $f = 10$ MHz	20	pF

AC LOADING and WAVEFORMS Generic for LCX Family

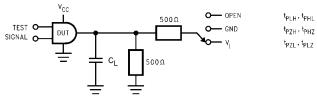
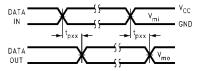
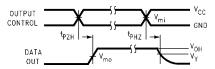


FIGURE 1. AC Test Circuit (C_L includes probe and jig capacitance)

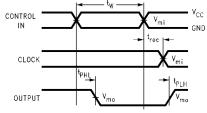
Test	Switch
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	6V at V_{CC} = 3.3 \pm 0.3V V_{CC} x 2 at V_{CC} = 2.5 \pm 0.2V
t_{PZH}, t_{PHZ}	GND



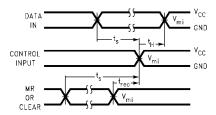
Waveform for Inverting and Non-Inverting Functions



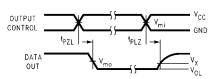
3-STATE Output High Enable and Disable Times for Logic



Propagation Delay. Pulse Width and t_{rec} Waveforms



Setup Time, Hold Time and Recovery Time for Logic



3-STATE Output Low Enable and Disable Times for Logic

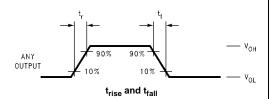
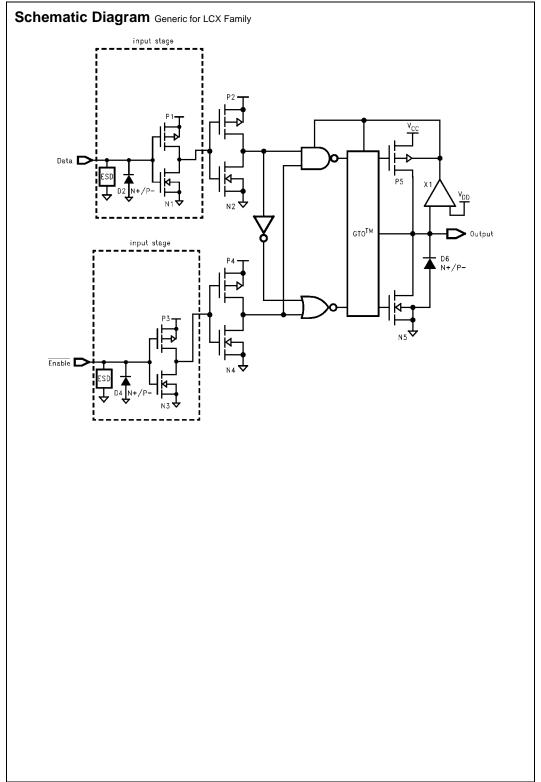
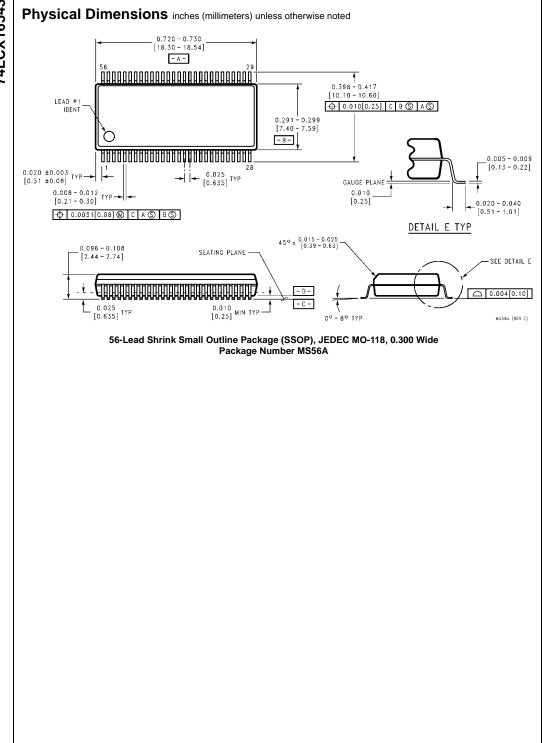
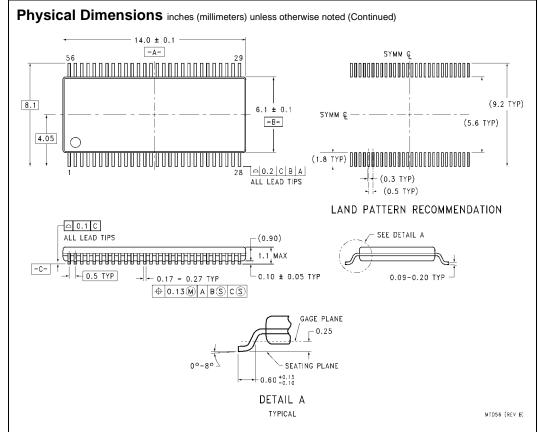


FIGURE 2. Waveforms (Input Characteristics; f =1MHz, $t_r = t_f = 3ns$)

Symbol		V _{CC}	
Cyllibol	$3.3V \pm 0.3V$	2.7V	$\textbf{2.5V} \pm \textbf{0.2V}$
V_{mi}	1.5V	1.5V	V _{CC} /2
V_{mo}	1.5V	1.5V	V _{CC} /2
V _x	V _{OL} + 0.3V	V _{OL} + 0.3V	V _{OL} + 0.15V
V _v	V _{OH} – 0.3V	V _{OH} – 0.3V	V _{OH} – 0.15V







56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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